### SN54HCT02, SN74HCT02 QUADRUPLE 2-INPUT POSITIVE-NOR GATES

SCLS065C - NOVEMBER 1988 - REVISED JUNE 2000

Inputs Are TTL-Voltage Compatible

 Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

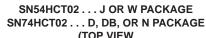
#### description

These devices contain four independent 2-input NOR gates. They perform the Boolean function  $Y = \overline{A} \cdot \overline{B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

The SN54HCT02 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74HCT02 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

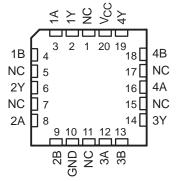
FUNCTION TABLE (each gate)								
INP	UTS	OUTPUT						
Α	В	Y						
Н	Х	L						
Х	Н	L						
L	L	н						

### logic symbol<sup>†</sup>

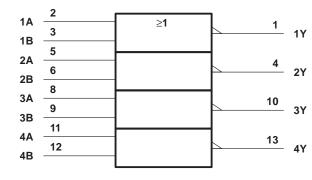


	(101	VIL VV	
1Y [ 1A [ 1B [ 2Y [ 2A [ 2B [ GND ]	2 3 4 5 6	12 11	] V <sub>CC</sub> ] 4Y ] 4B ] 4A ] 3Y ] 3B ] 3A

SN54HCT02 . . . FK PACKAGE (TOP VIEW)

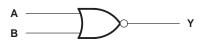


NC - No internal connection



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, N, and W packages.

### logic diagram, each gate (positive logic)





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### absolute maximum ratings over operating free-air temperature range<sup>†</sup>

Supply voltage range, $V_{CC}$ Input clamp current, $I_{IK}$ ( $V_I$ < 0 or $V_I$ > $V_{CC}$ ) (see	ee Note 1)	±20 mA
Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CO</sub>		
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$		±25 mA
Continuous current through V <sub>CC</sub> or GND		±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2):	: D package	86°C/W
	DB package	96°C/W
	N package	80°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 3)

			SN	154HCT02	SN	N74HCT02	2	UNIT
			MIN	NOM MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5 🔥 5.5	4.5	5	5.5	V
VIH	High-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2	N	2			V
VIL	Low-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	0	0.8	0		0.8	V
VI	Input voltage		0	Vcc	0		VCC	V
Vo	Output voltage		0	S Vcc	0		VCC	V
tt	Input transition (rise and fall) time		<u>9</u> C	500	0		500	ns
TA	Operating free-air temperature		-55	125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	TEST CONDITIONS		T <sub>A</sub> =		T <sub>A</sub> = 25°C		SN54HCT02		SN74HCT02	
PARAMETER	TEST CO	NDITION5	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
VOH	VI = VIH or VIL	I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
VOH	VI = VIH OL VIL	I <sub>OH</sub> = -4 mA	4.5 V	3.98	4.3		3.7	ĥ	3.84		v
Ve	$V_{I} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL	VI = VIH OI VIL	I <sub>OL</sub> = 4 mA	4.5 V		0.17	0.26		0.4		0.33	v
li	VI = ACC  or  0		5.5 V		±0.1	±100	1	±1000		±1000	nA
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	5.5 V			2	$D_{n_c}$	40		20	μA
∆ICC‡	One input at 0.5 V Other inputs at 0 or		5.5 V		1.4	2.4	10yd	3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.



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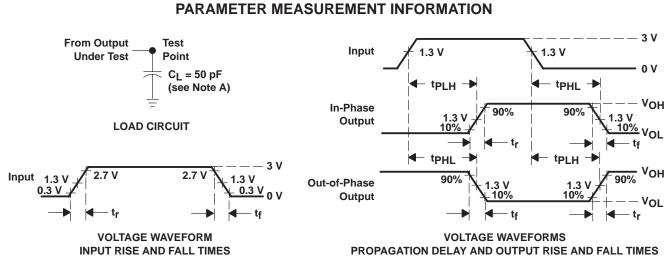
SCLS065C - NOVEMBER 1988 - REVISED JUNE 2000

# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

DADAMETED	PARAMETER FROM TO		Vee	Т	λ = 25°C	;	SN54HCT02	SN74HCT02	UNIT
FARAWETER	(INPUT)	Γ) (OUTPUT)	VCC	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT
<b>4</b> .	A or B	Y	4.5 V		11	20	30	25	20
τpd			5.5 V		10	18	27	22	ns
<b>*</b> .		Y	4.5 V		9	15	22	19	20
чt			5.5 V		8	14	20	17	ns

### operating characteristics, T<sub>A</sub> = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	20	pF



- NOTES: A. CL includes probe and test-fixture capacitance.
  - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 6 ns, t<sub>f</sub> = 6 ns.
  - C. The outputs are measured one at a time with one input transition per measurement.
  - D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

### Figure 1. Load Circuit and Voltage Waveforms



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